MX23L3210

32M-BIT (4M x 8 / 2M x 16) Mask ROM

FEATURES

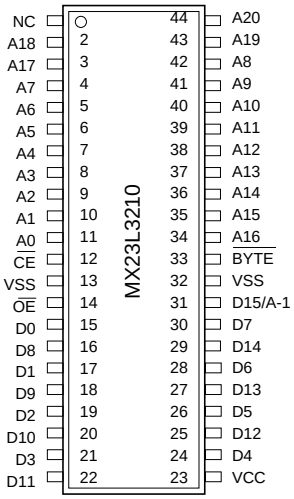
- Bit organization
  - 4M x 8 (byte mode)
  - 2M x 16 (word mode)
- Fast access time
  - Random access:70ns (max.) for 3.0V~3.6V
    90ns (max.) for 2.7V~3.6V
- Current
  - Operating:40mA
  - Standby:15uA
- Supply voltage
  - 2.7V~3.6V
- Package
  - 44 pin SOP (500mil)
  - 48 pin TSOP (12mm x 20mm)
  - 44 pin TSOP (Type II)

ORDER INFORMATION

Part No.	Access Time	Package
MX23L3210MC-10	100ns	44 pin SOP
MX23L3210MC-12	120ns	44 pin SOP
MX23L3210MC-15	150ns	44 pin SOP
MX23L3210TC-70	70ns	48 pin TSOP
MX23L3210TC-90	90ns	48 pin TSOP
MX23L3210TC-10	100ns	48 pin TSOP
MX23L3210TC-12	120ns	48 pin TSOP
MX23L3210TC-15	150ns	48 pin TSOP
MX23L3210RC-70	70ns	48 pin TSOP (Reverse type)
MX23L3210RC-90	90ns	48 pin TSOP (Reverse type)
MX23L3210RC-10	100ns	48 pin TSOP (Reverse type)
MX23L3210RC-12	120ns	48 pin TSOP (Reverse type)
MX23L3210RC-15	150ns	48 pin TSOP (Reverse type)
MX23L3210YC-10	100ns	44 pin TSOP
MX23L3210YC-12	120ns	44 pin TSOP

PIN CONFIGURATION

44 SOP/ 44 TSOP



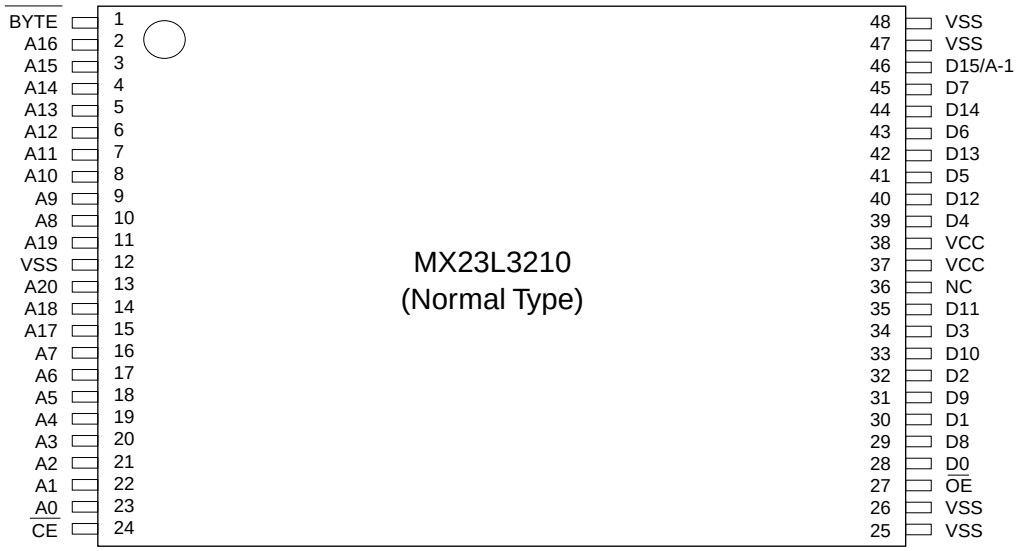
PIN DESCRIPTION

Symbol	Pin Function
A0~A20	Address Inputs
D0~D14	Data Outputs
D15/A-1	D15 (Word Mode)/ LSB Address (Byte Mode)
$\overline{CE}$	Chip Enable Input
$\overline{OE}$	Output Enable Input
$\overline{Byte}$	Word/ Byte Mode Selection
VCC	Power Supply Pin
VSS	Ground Pin
NC	No Connection

MODE SELECTION

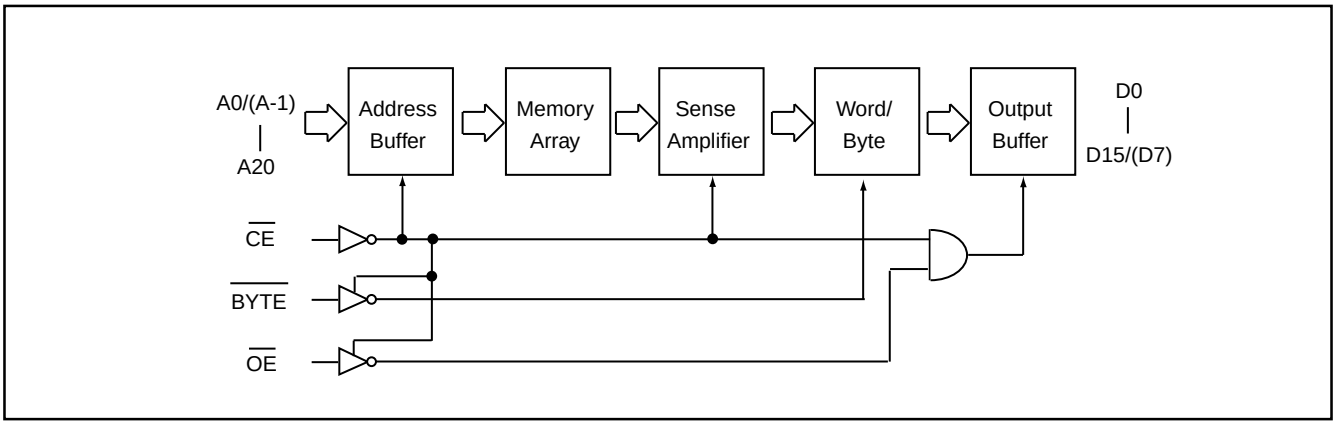
$\overline{CE}$	$\overline{OE}$	$\overline{Byte}$	D15/A-1	D0~D7	D8~D15	Mode	Power
H	X	X	X	High Z	High Z	-	Stand-by
L	H	X	X	High Z	High Z	-	Active
L	L	H	Output	D0~D7	D8~D15	Word	Active
L	L	L	Input	D0~D7	High Z	Byte	Active

48 TSOP (Normal Type)



48 TSOP (Reverse Type)

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Ratings
Voltage on any Pin Relative to VSS	VIN	-0.3V to 3.9V
Ambient Operating Temperature	Topr	0° C to 70° C
Storage Temperature	Tstg	-65° C to 125° C

DC CHARACTERISTICS (Ta = 0° C ~ 70° C, VCC = 2.7V~3.6V)

Item	Symbol	MIN.	MAX.	Conditions
Output High Voltage	VOH	2.3V	-	IOH = -0.4mA
Output Low Voltage	VOL	-	0.4V	IOL = 1.6mA
Input High Voltage	VIH	2.1V	VCC+0.3V	
Input Low Voltage	VIL	-0.3V	0.2xVCC	
Input Leakage Current	ILI	-	5uA	0V, VCC
Output Leakage Current	ILO	-	5uA	0V, VCC
Operating Current	ICC1	-	40mA	tRC = 120ns, all output open
Standby Current (TTL)	ISTB1	-	1mA	$\overline{CE}$ = VIH
Standby Current (CMOS)	ISTB2	-	15uA	$\overline{CE}$>VCC-0.2V
Input Capacitance	CIN	-	10pF	Ta = 25° C, f = 1MHZ
Output Capacitance	COUT	-	10pF	Ta = 25° C, f = 1MHZ

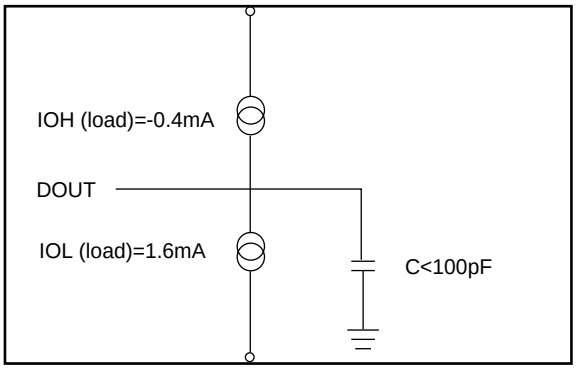
AC CHARACTERISTICS (Ta = 0° C ~ 70° C, VCC = 3.0V~3.6V)

Item	Symbol	23L3210-70		23L3210-90		23L3210-10		23L3210-12		23L3210-15	
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.
Read Cycle Time	tRC	70ns	-	90ns	-	100ns	-	120ns	-	150ns	-
Address Access Time	tAA	-	70ns	-	90ns	-	100ns	-	120ns	-	150ns
Chip Enable Access Time	tACE	-	70ns	-	90ns	-	100ns	-	120ns	-	150ns
Output Enable Time	tOE	-	35ns	-	45ns	-	50ns	-	60ns	-	70ns
Output Hold After Address	tOH	0ns	-	0ns	-	0ns	-	0ns	-	0ns	-
Output High Z Delay	tHZ	-	20ns	-	20ns	-	20ns	-	20ns	-	20ns

Note: Output high-impedance delay (tHZ) is measured from $\overline{OE}$ going high, and this parameter guaranteed by design over the full voltage and temperature operating range - not tested.

AC Test Conditions

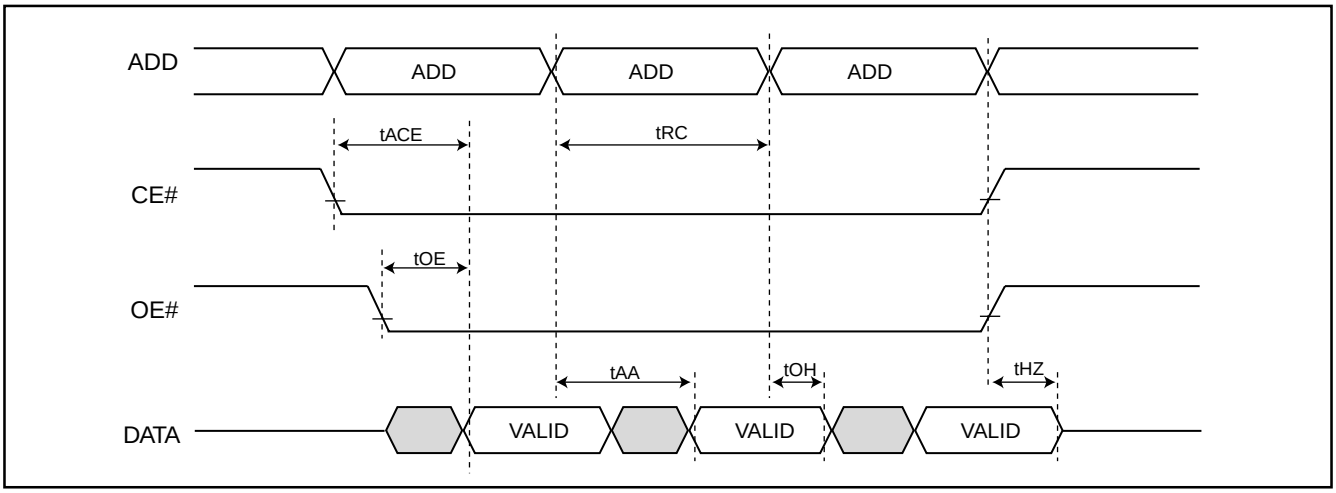
Input Pulse Levels	0.4V~2.4V
Input Rise and Fall Times	10ns
Input Timing Level	1.4V
Output Timing Level	1.4
Output Load	See Figure



Note: No output loading is present in tester load board.
Active loading is used and under software programming control.
Output loading capacitance includes load board's and all stray capacitance.

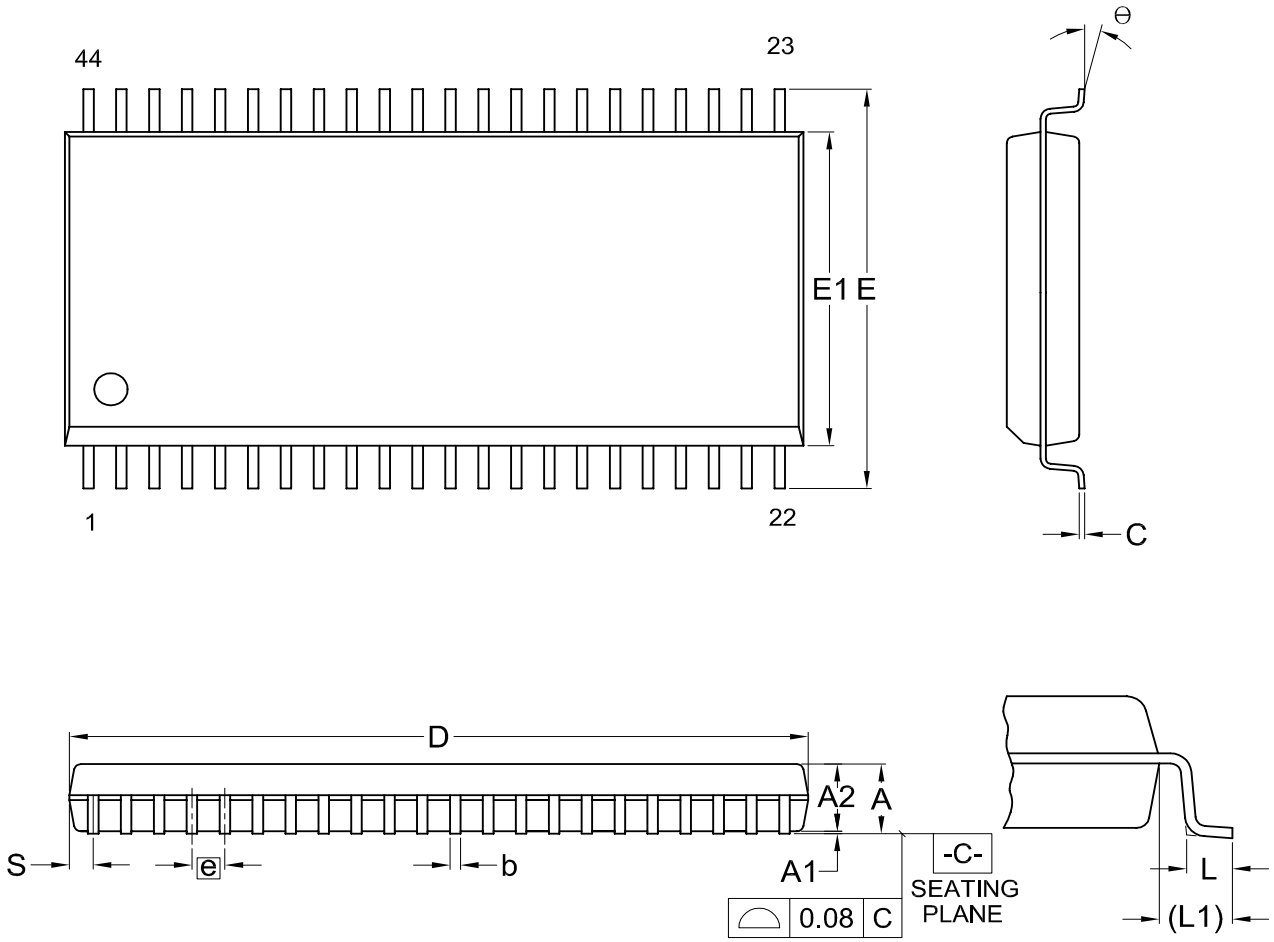
TIMING DIAGRAM

RANDOM READ



PACKAGE INFORMATION

Title: Package Outline for SOP 44L (500MIL)

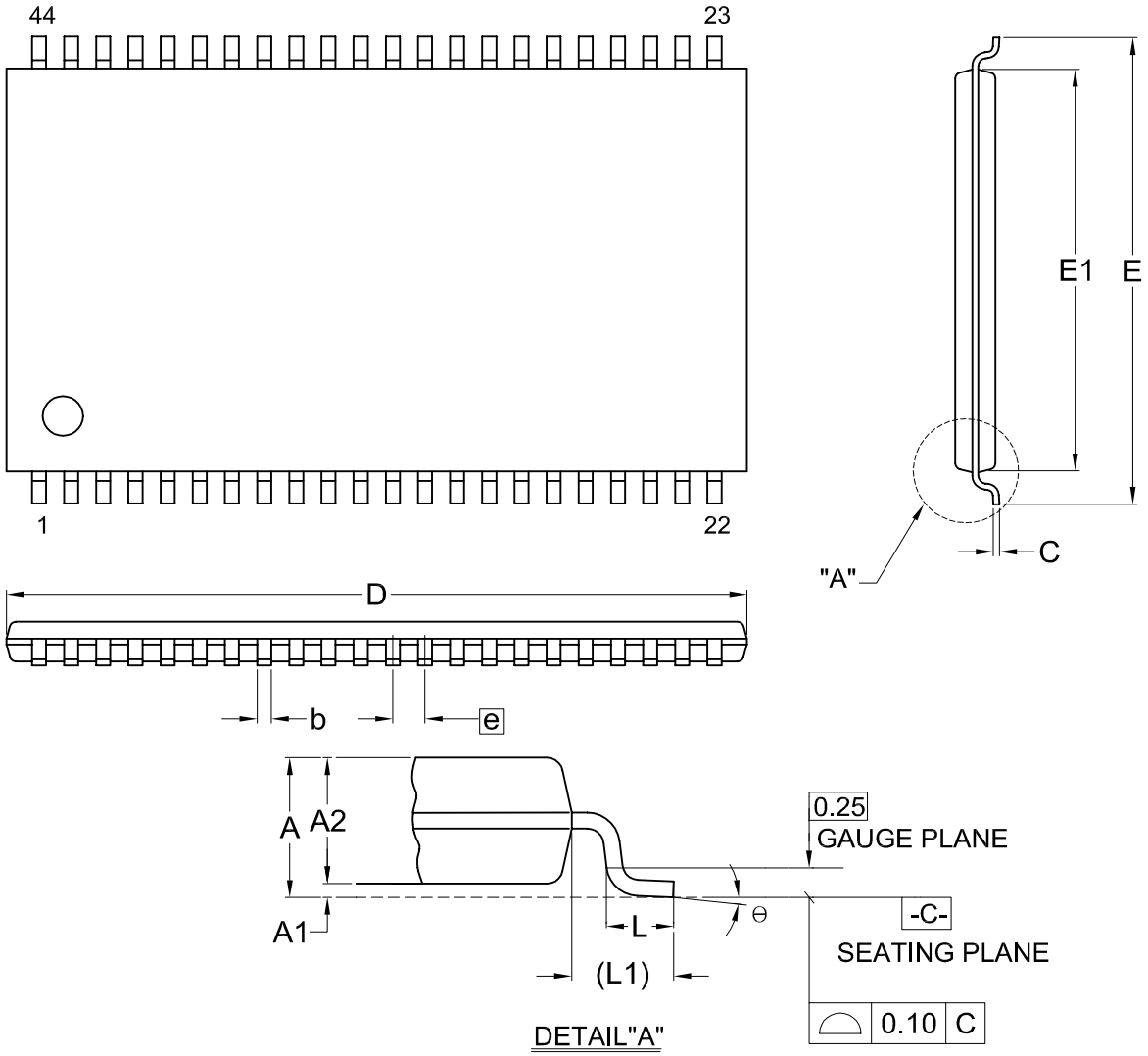


Dimensions (inch dimensions are derived from the original mm dimensions)

SYMBOL / UNIT		A	A1	A2	b	C	D	E	E1	e	L	L1	S	θ
mm	Min.	---	0.10	2.59	0.36	0.15	28.37	15.83	12.47		0.56	1.51	0.78	0
	Nom.	---	0.15	2.69	0.41	0.20	28.50	16.03	12.60	1.27	0.76	1.71	0.91	5
	Max.	3.00	0.20	2.80	0.51	0.25	28.63	16.23	12.73		0.96	1.91	1.04	10
Inch	Min.	---	0.004	0.102	0.014	0.006	1.117	0.623	0.491		0.022	0.059	0.031	0
	Nom.	---	0.006	0.106	0.016	0.008	1.122	0.631	0.496	0.050	0.030	0.067	0.036	5
	Max.	0.118	0.008	0.110	0.020	0.010	1.127	0.639	0.501		0.038	0.075	0.041	10

DWG.NO.	REVISION	REFERENCE			ISSUE DATE
		JEDEC	EIAJ		
6110-1405	6	MO-175			11-26-'03

Title: **Package Outline for TSOP(II) 44L (400MIL)**

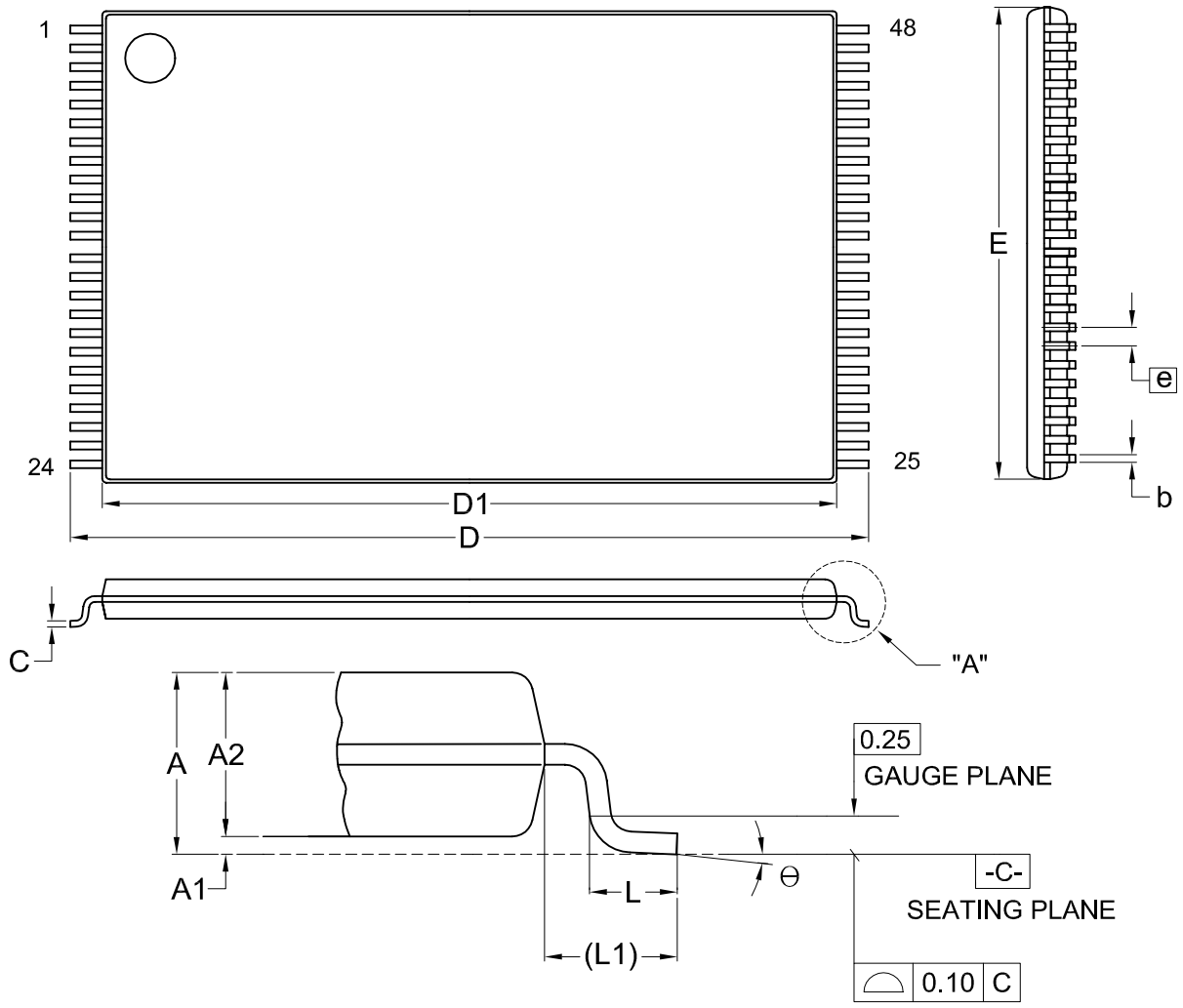


Dimensions (inch dimensions are derived from the original mm dimensions)

SYMBOL / UNIT		A	A1	A2	b	C	D	E	E1	e	L	L1	Θ
mm	Min.	---	0.05	0.95	0.30	0.12	18.31	11.56	10.06		0.40	0.70	0
	Nom.	---	0.10	1.00	0.35	0.15	18.41	11.76	10.16	0.80	0.50	0.80	5
	Max.	1.20	0.15	1.05	0.45	0.21	18.51	11.96	10.26		0.60	0.90	8
Inch	Min.	---	0.002	0.037	0.012	0.005	0.721	0.455	0.396		0.016	0.028	0
	Nom.	---	0.004	0.039	0.014	0.006	0.725	0.463	0.400	0.031	0.020	0.031	5
	Max.	0.047	0.006	0.041	0.018	0.008	0.729	0.471	0.404		0.024	0.035	8

DWG.NO.	REVISION	REFERENCE			ISSUE DATE
		JEDEC	EIAJ		
6110-1701	6	MS-024			12-01-'03

Title: **Package Outline for TSOP(I) 48L (12X20mm)NORMAL FORM**



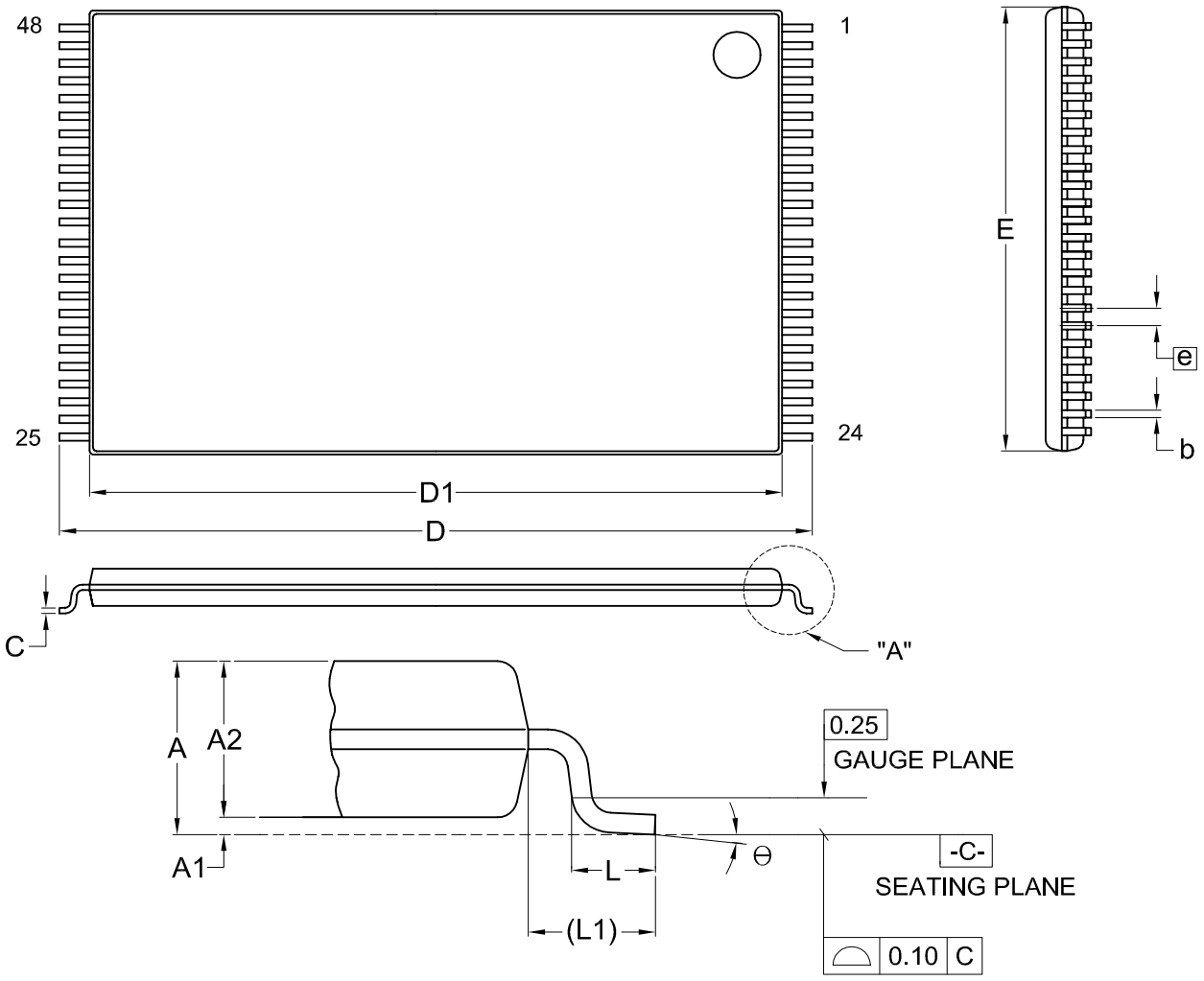
DETAIL"A"

Dimensions (inch dimensions are derived from the original mm dimensions)

SYMBOL / UNIT		A	A1	A2	b	C	D	D1	E	e	L	L1	Θ
mm	Min.	---	0.05	0.95	0.17	0.10	19.80	18.30	11.90		0.50	0.70	0
	Nom.	---	0.10	1.00	0.20	0.13	20.00	18.40	12.00	0.50	0.60	0.80	5
	Max.	1.20	0.15	1.05	0.27	0.21	20.20	18.50	12.10		0.70	0.90	8
Inch	Min.	---	0.002	0.037	0.007	0.004	0.780	0.720	0.469		0.020	0.028	0
	Nom.	---	0.004	0.039	0.008	0.005	0.787	0.724	0.472	0.020	0.024	0.031	5
	Max.	0.047	0.006	0.041	0.011	0.008	0.795	0.728	0.476		0.028	0.035	8

DWG.NO.	REVISION	REFERENCE			ISSUE DATE
		JEDEC	EIAJ		
6110-1607	7	MO-142			12-01-'03

Title: **Package Outline for TSOP(I) 48L (12X20mm)REVERSE FORM**



DETAIL"A"

Dimensions (inch dimensions are derived from the original mm dimensions)

SYMBOL / UNIT		A	A1	A2	b	C	D	D1	E	e	L	L1	Θ
mm	Min.	---	0.05	0.95	0.17	0.10	19.80	18.30	11.90		0.50	0.70	0
	Nom.	—	0.10	1.00	0.20	0.13	20.00	18.40	12.00	0.50	0.60	0.80	5
	Max.	1.20	0.15	1.05	0.27	0.21	20.20	18.50	12.10		0.70	0.90	8
Inch	Min.	—	0.002	0.037	0.007	0.004	0.780	0.720	0.469		0.020	0.028	0
	Nom.	---	0.004	0.039	0.008	0.005	0.787	0.724	0.472	0.020	0.024	0.031	5
	Max.	0.047	0.006	0.041	0.011	0.008	0.795	0.728	0.476		0.028	0.035	8

DWG.NO.	REVISION	REFERENCE			ISSUE DATE
		JEDEC	EIAJ		
6110-1607.1	7	MO-142			12-01-'03

REVISION HISTORY

REVISION	DESCRIPTION	PAGE	DATE
2.5	AC CHARACTERISTICS tOH 10ns-->0ns	P4	JAN/29/1999
2.6	Add 120ns (max.) for 3.0V~3.6V ; 150ns(max.) for 2.7V~3.6V	P1	Dec/24/1999
	DC characteristics Standby current (ISTB2):5uA-->15uA	P1,3	
	AC characteristics 120ns for 3.0V~3.6V	P4	
2.7	1. Added access time:100ns	P1,4	JUN/28/2001
	2. Modify Package Information	P5,6	
2.8	1. Added 44-pin TSOP(II)	P1,7	JUL/17/2001
2.9	1. Added access time:70ns & 90ns	P1,4	MAY/14/2002
3.0	Modify Package Information	P5~8	NOV/21/2002
3.1	Change 2.7~3.6V 150ns-->2.7~3.6V 90ns	P1	MAY/19/2004

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